

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JEONG-FA SHEU	08/23/2021
CHEN-KUO HWANG	08/23/2021
MEI-CHUAN LU	08/23/2021
WEI-CHUNG CHO	08/23/2021
RECEIVING PARTY DATA	
Name:	REALTEK SEMICONDUCTOR CORPORATION
Street Address:	NO. 2, INNOVATION RD. II, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	30076
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17409871
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	TIM TINGKANG XIA
SIGNATURE:	/Tim Tingkang Xia/
DATE SIGNED:	08/24/2021
Total Attachments: 2	
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source=0114973396US2Assignment#page2.tif	

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) _____
TEST CIRCUIT

The PATENT RIGHTS referred to in this agreement are:

(check one) a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

U.S. patent application Serial No. _____, filed _____

a U.S. patent application based on PCT International Application No. _____ filed on (date) _____ (U.S. patent application Serial No. _____, if known).

U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

U.S. patent rights only.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Realtek Semiconductor Corporation

(Address) No. 2, Innovation Rd. II, Hsinchu Science Park, Hsinchu 30076, Taiwan, R.O.C.

The ASSIGNEE is:

(check one) An individual.

A Partnership.

A Corporation of TAIWAN, R.O.C. (specify state or country)

(other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
ASSIGNEE: Realtek Semiconductor Corporation
INVENTION TITLE: TEST CIRCUIT

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Jeong-Fa SHEU</u> Name of sole or first inventor	<u>Jeong-Fa Sheu</u> Signature	<u>08/23/2021</u> Date
<u>Chen-Kuo HWANG</u> Name of second inventor, if any	<u>Chen-Kuo Huang</u> Signature	<u>08/23/2021</u> Date
<u>Mei-Chuan LU</u> Name of third inventor, if any	<u>Mei-Chuan Lu</u> Signature	<u>08/23/2021</u> Date
<u>Wei-Chung CHO</u> Name of fourth inventor, if any	<u>Wei-Chung CHO</u> Signature	<u>08/23/2021</u> Date